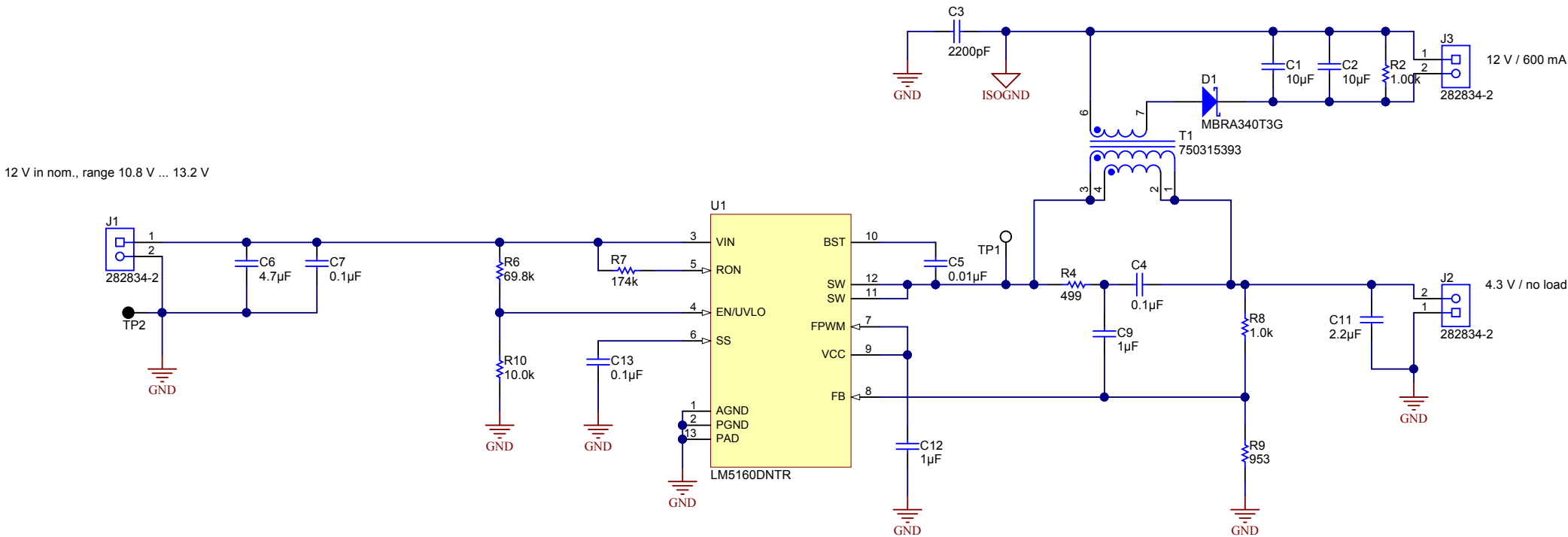


Revision History	
Revision	Notes
A	* First release

- Notes:
- R7 = 174k sets fsw to 300kHz
 - UVLO is set to 9.9 V
 - Duty Cycle is set to approx. 33% due to transformer turns ratio of 1:3



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Number: **PMP10152** | Rev: **A**
SVN Rev: Version control disabled
Drawn By: **M. Zehendner**
Engineer: **M. Zehendner**

Designed for: **Public Release** | Mod. Date: 6/3/2015
Project Title: **Telecom Flyback**
Sheet Title: **PMP10152RevA**
Assembly Variant: **001** | Sheet: **1** of **1**
File: **PMP10152RevA - Circuit.SchDoc** | Size: **A3**
Contact: **<http://www.ti.com/support>**

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